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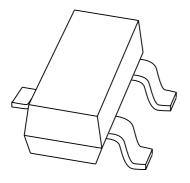
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Kind regards,

Team Nexperia

DISCRETE SEMICONDUCTORS

DATA SHEET



PBSS4230T 30 V, 2 A NPN low V_{CEsat} (BISS) transistor

Product data sheet 2003 Sep 29



30 V, 2 A NPN low V_{CEsat} (BISS) transistor

PBSS4230T

FEATURES

- Low collector-emitter saturation voltage V_{CEsat}
- High collector current capability I_C and I_{CM}
- · High efficiency leading to less heat generation
- Reduced printed-circuit board requirements
- Cost effective alternative to MOSFETs in specific applications.

APPLICATIONS

- · Power management
 - DC/DC conversion
 - Supply line switching
 - Battery charger
 - LCD backlighting.
- Peripheral driver
 - Driver in low supply voltage applications (e.g. lamps and LEDs)
 - Inductive load drivers (e.g. relays, buzzers and motors).

DESCRIPTION

NPN BISS transistor in a SOT23 plastic package providing ultra low $\rm V_{CEsat}$ and $\rm R_{CEsat}$ parameters.

PNP complement: PBSS5230T.

MARKING

TYPE NUMBER	MARKING CODE ⁽¹⁾
PBSS4230T	*3D

Note

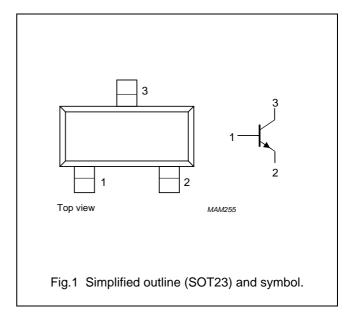
- 1. * = p: made in Hong Kong.
 - * = t: made in Malaysia.
 - * = W: made in China.

QUICK REFERENCE DATA

SYMBOL	PARAMETER	MAX.	UNIT
V _{CEO}	V _{CEO} collector-emitter voltage		V
I _C collector current (DC)		2	Α
I _{CM} peak collector current		3	Α
R _{CEsat} equivalent on-resistance		200	mΩ

PINNING

PIN	DESCRIPTION	
1	base	
2	emitter	
3	collector	



ORDERING INFORMATION

TYPE NUMBER		PACKAGE		
TIPE NOWBER	NAME DESCRIPTION VERSION			
PBSS4230T	_	plastic surface mounted package; 3 leads	SOT23	

30 V, 2 A NPN low V_{CEsat} (BISS) transistor

PBSS4230T

LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 60134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V _{CBO}	collector-base voltage	open emitter	_	40	٧
V _{CEO}	collector-emitter voltage	open base	_	30	V
V _{EBO}	emitter-base voltage	open collector	_	5	V
I _C	collector current (DC)		_	2	Α
I _{CM}	peak collector current		_	3	Α
I _{BM}	peak base current		_	300	mA
P _{tot}	total power dissipation	T _{amb} ≤ 25 °C; note 1	_	300	mW
		T _{amb} ≤ 25 °C; note 2	_	480	mW
T _{stg}	storage temperature		-65	+150	°C
Tj	junction temperature		_	150	°C
T _{amb}	operating ambient temperature		-65	+150	°C

Notes

- 1. Device mounted on a FR4 printed-circuit board, single-sided copper, tinplated, standard footprint.
- 2. Device mounted on a FR4 printed-circuit board, single-sided copper, tinplated, mounting pad for collector 1 cm².

THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	CONDITIONS	VALUE	UNIT
R _{th j-a}	thermal resistance from junction to ambient	in free air; note 1	417	K/W
		in free air; note 2	260	K/W

Notes

- 1. Device mounted on a FR4 printed-circuit board, single-sided copper, tinplated, standard footprint.
- 2. Device mounted on a FR4 printed-circuit board, single-sided copper, tinplated, mounting pad for collector 1 cm².

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CHARACTERISTICS

 T_{amb} = 25 °C unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS		TYP.	MAX.	UNIT
I _{CBO}	collector-base cut-off current	V _{CB} = 30 V; I _E = 0	_	_	100	nA
		V _{CB} = 30 V; I _E = 0; T _j = 150 °C	_	_	50	μΑ
I _{EBO}	emitter-base cut-off current	V _{EB} = 4 V; I _C = 0	_	_	100	nA
h _{FE}	DC current gain	V _{CE} = 2 V; I _C = 100 mA	350	470	-	
		V _{CE} = 2 V; I _C = 500 mA	300	450	-	
		V _{CE} = 2 V; I _C = 1 A	300	420	-	
		V _{CE} = 2 V; I _C = 2 A	150	250	-	
V _{CEsat}	collector-emitter saturation voltage	I _C = 100 mA; I _B = 1 mA	_	45	70	mV
		$I_C = 500 \text{ mA}; I_B = 50 \text{ mA}$	_	70	100	mV
		I _C = 750 mA; I _B = 15 mA	_	120	180	mV
		I _C = 1 A; I _B = 50 mA; note 1	_	130	180	mV
		I _C = 2 A; I _B = 200 mA; note 1	_	240	320	mV
R _{CEsat}	equivalent on-resistance	$I_C = 500 \text{ mA}$; $I_B = 50 \text{ mA}$; note 1	_	140	200	mΩ
V _{BEsat}	base-emitter saturation voltage	I _C = 2 A; I _B = 200 mA; note 1	_	_	1.1	V
V_{BEon}	base-emitter turn-on voltage	V _{CE} = 2 V; I _C = 100 mA	_	_	0.75	V
f⊤	transition frequency	I _C = 100 mA; V _{CE} = 10 V; f = 100 MHz	100	230	_	MHz
C _c	collector capacitance	$V_{CB} = 10 \text{ V}; I_E = I_e = 0; f = 1 \text{ MHz}$	_	15	20	pF

Note

1. Pulse test: $t_p \leq 300~\mu s;~\delta \leq 0.02.$

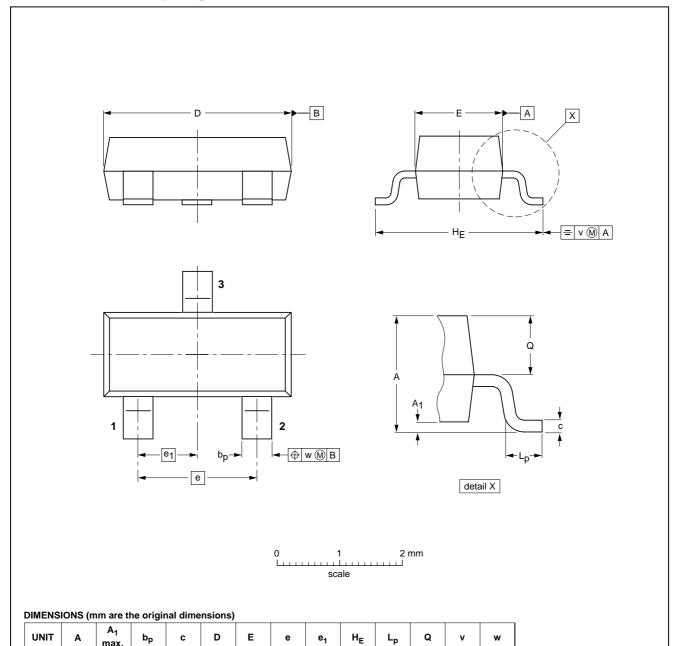
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PACKAGE OUTLINE

Plastic surface mounted package; 3 leads

SOT23



OUTLINE		REFER	ENCES	EUROPEAN	ISSUE DATE
VERSION	IEC JEDEC		EIAJ	PROJECTION	1330E DATE
SOT23		TO-236AB		$ \ \ \bigoplus \big($	-97-02-28- 99-09-13

0.95

0.45

0.15

0.55

0.45

0.1

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0.48

0.38

0.1

mm

0.15

0.09

3.0

2.8

1.4

1.9

30 V, 2 A NPN low V_{CEsat} (BISS) transistor

PBSS4230T

DATA SHEET STATUS

DOCUMENT STATUS ⁽¹⁾	PRODUCT STATUS ⁽²⁾	DEFINITION
Objective data sheet	Development	This document contains data from the objective specification for product development.
Preliminary data sheet	Qualification	This document contains data from the preliminary specification.
Product data sheet	Production	This document contains the product specification.

Notes

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NXP Semiconductors

Customer notification

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Contact information

For additional information please visit: http://www.nxp.com

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